APPLICA	BLE STAI											
	OPERATING TEMPERATURE RANGE OPERATING HUMIDITY RANGE VOLTAGE		-55 °C TO +85 °C (1) (2)			STORAGE TEMPERATURE RANGE		ΕT	-10 °C TO +60 °C	C (3)		
RATING			RH 90 % MAX (2) (4) RAP			STORAGE HUMIDITY RANGE			RH 70 % MAX (3) (4) Apply to spec of applicable connection			
											ecto	
				CIFICA	TION	S			, 4-1-1-1-1-1-1-1-1-1-1-1-1-1-1-1-1-1-1-1			
IT	EM		TEST METHOD				RE	QU	IREMENTS	QT	TA	
CONSTRI										1	1	
	XAMINATIOI	N VISUAL AI	ND WITH MEASURING INSTRU	UMENT		ACCOR	DING TO E	)RAV	WING	×	×	
MARKING		CONFIRM	ED VISUALLY							×	>	
	CHARA		CS							_		
CONTACT RESISTANCE		100 mA OI	100 mA OPEN CIRCUIT MAX.			2 mΩ MAX. <sup>(5)</sup>				×	>	
[EIA-364-23] INSULATION RESISTANCE		;E				MATED WITH IT-P-2P-14H				×		
[LIA-304-21]		500 V DC	500 V DC				1000 M Ω MIN.					
VOLTAGE PROOF		1000 V AC	1000 V AC FOR 1 MINUTE				NO FLASHOVER OR BREAKDOWN.					
EIA-364-20]			CTICC									
INSERTION	CAL CHA			^ARI E		INISEDT	ION FORC	· E ·	75 N MAX / Pair	1	T	
WITHDRAWAL FORCES		I	MEASURED WITH RESPECT TO APPLICABLE CONNECTORS				INSERTION FORCE: 75 N MAX / Pair WITHDRAWAL FORCE: 3 N MIN. / Pair					
[EIA-364-13]										×	L	
MECHANICAL		100 TIMES	100 TIMES INSERTION AND EXTRACTION				① CONTACT RESISTANCE: 2 mΩ MAX. (5)					
OPERATION [EIA-364-09]							② NO DAMAGE, CRACK OR LOOSENESS OF PARTS					
RANDOM VIBRATION		FREQUEN	FREQUENCY: 50 TO 2000 Hz				1 NO ELECTRICAL DISCONTINUITY OF 1 µs OR				-	
[EIA-364-28]		I	POWER SPECTRAL DENSITY : 0.1 g <sup>2</sup> /Hz				MORE					
		1	FOR 90 MINUTES IN THREE DIRECTIONS  * The test PCB has been fixed by spacers.				DAMAGE, ( RTS	CRA	CK OR LOOSENESS OF			
SHOCK			490 m/s <sup>2</sup> , DURATION OF PULSE: 11 ms				(15				+	
EIA-364-27]			18 TIMES TOTAL, 3 EACH DIRECTION, 3 AXIS									
			t PCB has been fixed by space	ers.								
			TERISTICS	05.00		@ 001	T. O. T. D. C.	VOT.	NIOT O O MAY (5)		1	
THERMAL SHOCK [EIA-364-32]		1	TEMPERATURE: $-55 \rightarrow 20 \sim 35 \rightarrow 85 \rightarrow 20 \sim 35 ^{\circ}\text{C}$ TIME: $30 \rightarrow 5 \text{ MAX} \rightarrow 30 \rightarrow 5 \text{ MAX}$ min. UNDER 10 CYCLES				① CONTACT RESISTANCE : 2 mΩ MAX. <sup>(5)</sup> ② INSULATION RESISTANCE : 100 MΩ MIN.					
									CK OR LOOSENESS OF	×		
CYCLIC TEMPERATURE		@ 25 °C, 8	@ 25 °C, 80% RH: 60 MIN DWELL TIME				PARTS					
AND HUMIDITY EIA-364-31]		@ 65 °C 5	30 MIN RAMP TIME @ 65 °C, 50% RH: 60 MIN DWELL TIME									
_LIA-304-31]		UNDER 24										
DRY HEAT		EXPOSED	EXPOSED AT 105 °C, 120 hr				① CONTACT RESISTANCE: 2 mΩ MAX. (5)					
[EIA-364-17]							② NO DAMAGE, CRACK OR LOOSENESS OF PARTS					
MIXED FLOWING GAS		EXPOSED	EXPOSED AT 30 °C, 70%				① CONTACT RESISTANCE : 2 m Ω MAX. (5)					
[EIA-364-65]			$Cl_2$ : 10 ppb, $NO_2$ : 200 ppb, $H_2S$ : 10 ppb, $SO_2$ : 100 ppb UNMATED 7 DAYS, MATED 7 DAYS				② NO HEAVY CORROSION					
			PRECONDITION AT 60 °C, 60% RH FOR 120 hr				NO DEFORMATION OF CASE OF EXCESSIVE					
CONDITION [IPC / JEDEC STD-020]		SURFACE	REFLOW PEAK TEMPERATURE : 260 °C AT CONNETO			LOOSE	NESS OF THE TERMINAL.			×		
IFC / JLDLC	310-020]											
				1								
COUN	IT	DESCRIPTION	ON OF REVISIONS		DESIG	NED			CHECKED	DA	ΥΈ	
<u> </u>									T			
REMARKS		NOT CALIFED D	/ OUDDENT OADDVING				APPROV	/ED	MK. EZAKI	14. 1	1. 2	
(1) INCLUDE TIMPERATURE RISE CAUSED BY CURRENT-CARRYING. (2) OPERATING TEMPERATURE SHOULD BE -55 TO 55°C WHEN HUMIDITY EXCEEDS 80% RH. (3) "STORAGE" MEANS A LONG-TERM STORAGE STATE FOR THE UNUSED PRODUCT BEFORE ASSEMBLY TO PCB.												
						CHE		ED	TS. OSHIDA		1.2	
(4) NO DEW CO	ONDENSATION I	S PERMITTED.	PERMITTED. SISTANCE INCLUDES 2 CONTACT POINTS AND THE BULK RESISTAN				DESIGNED DRAWN		NY. SHIMURA 14		1. 2	
									NY. SHIMURA 14		1. 2	
Note; QT:Qu	alification Te	st AT:Assui	Assurance Test X:Applicable Test D			RAWING NO.			ELC4-354232-00			
ınc	CATION SHEET	HEET PAI		NO.		IT-P-2S-DIRL						
HS.							01	000		_	4 1	
	⊣ HI	KUSE El	LECTRIC CO., LTD.		CODE	NO.	UL	036	6-0611-3-00	0	1/	